# onsemi

# Switch-mode Power Rectifier

**DPAK Surface Mount Package** 

# SURD8530T4G-VF01

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

#### Features

- Ultrafast 50 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage
- SURD8 Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### **Mechanical Characteristics**

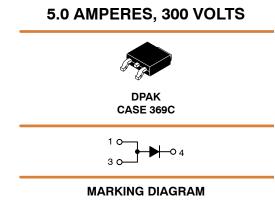
• Case: Epoxy, Molded

MAXIMUM BATINGS

- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	300	V
Average Rectified Forward Current (T <sub>C</sub> = 165°C)	I <sub>F(AV)</sub>	5.0	A
Peak Repetitive Forward Current (Square Wave, Duty = 0.5, T <sub>C</sub> = 165°C)	I <sub>FRM</sub>	10	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz)	I <sub>FSM</sub>	75	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



ULTRAFAST RECTIFIER



U530 = Specific Device Number

A = Assembly Location\*

Y = Year

WW = Work Week G = Pb-Free Package

\* The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
SURD8530T4G-VF01	DPAK (Pb–Free)	2500 / Tape & Reel

#### DISCONTINUED (Note 1)

MURD530T4G	DPAK (Pb–Free)	2500 / Tape & Reel
SURD8530T4G	DPAK (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D.</u>

 DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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## SURD8530T4G-VF01

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Case (Note 1)	$R_{\theta JC}$	3	°C/W
Thermal Resistance – Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	92	°C/W
Thermal Resistance – Junction-to-Ambient (Note 3)	R <sub>0JA</sub>	57	°C/W

1. Rating applies for one diode leg.

Rating applies when for both diode legs when mounted on 130 mm<sup>2</sup> pad size. 2.

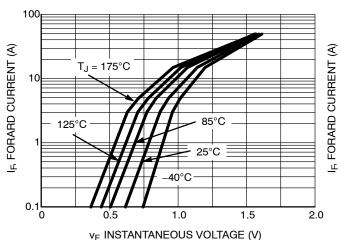
3. Rating applies for both diode legs when mounted on 1 in pad size.

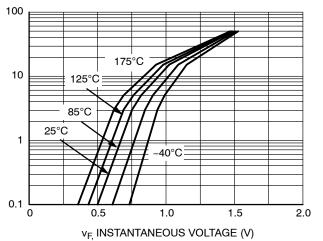
#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
$\begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage Drop (Note 4)} \\ (i_F = 3 \mbox{ A, } T_J = 25^{\circ} \mbox{C}) \\ (i_F = 3 \mbox{ A, } T_J = 125^{\circ} \mbox{C}) \\ (i_F = 5 \mbox{ A, } T_J = 25^{\circ} \mbox{C}) \\ (i_F = 5 \mbox{ A, } T_J = 125^{\circ} \mbox{C}) \end{array}$	۷ <sub>F</sub>	0.95 0.80 1.05 0.90	Volts
Maximum Instantaneous Reverse Current (Note 4) ( $T_J = 25^{\circ}C$ , Rated dc Voltage) ( $T_J = 125^{\circ}C$ , Rated dc Voltage)	İR	5.0 150	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1 Amp, di/dt = 50 A/ $\mu$ s, V <sub>R</sub> = 30 V, T <sub>J</sub> = 25°C)	t <sub>rr</sub>	50	ns

4. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

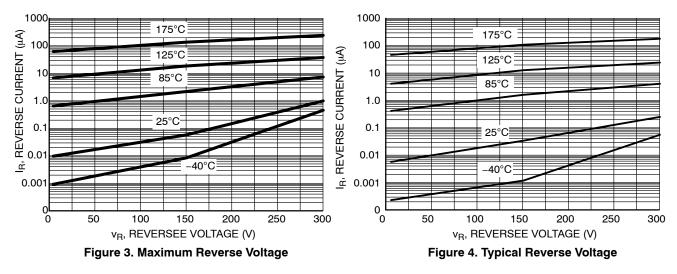
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.











## SURD8530T4G-VF01

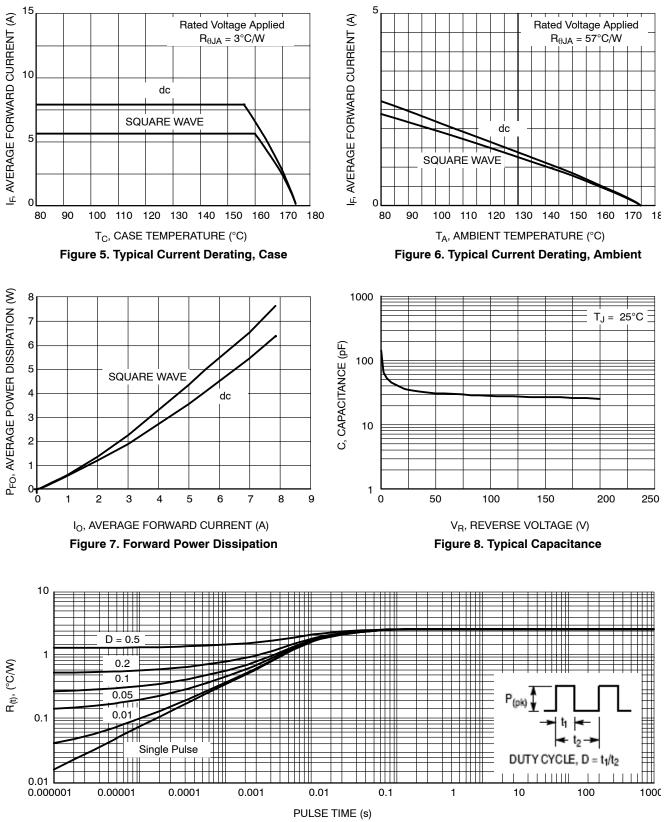


Figure 9. R<sub>(t)</sub> on an Infinite Heatsink Power (J1) 0.800 W Power (J2) 0.800 W

## SURD8530T4G-VF01

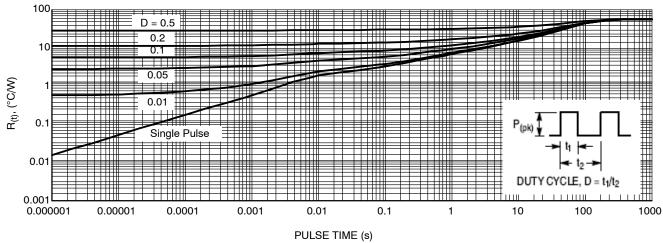
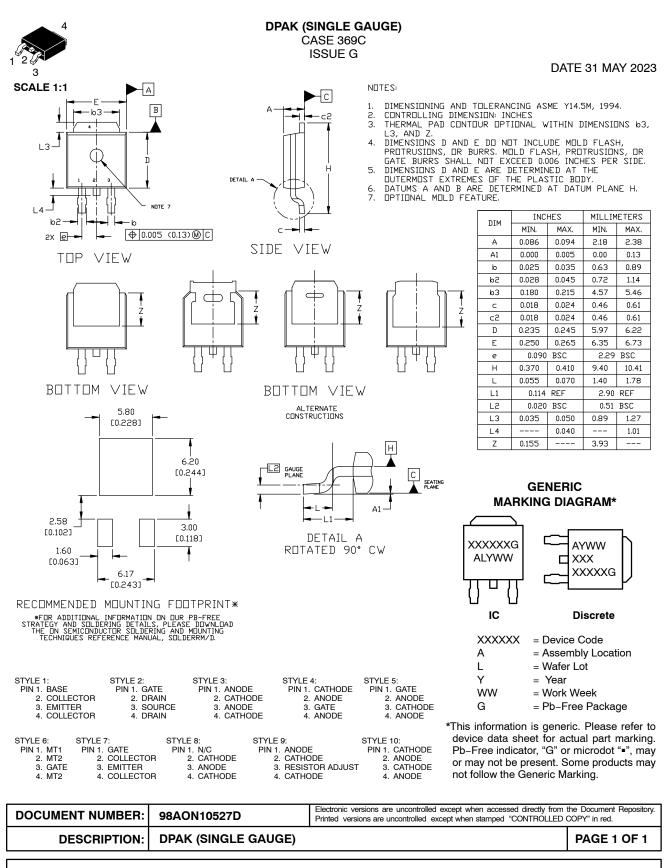


Figure 10. PCB Cu Area 650 mm<sup>2</sup> PCB Cu thk 1 oz Power (J1) 0.800 W Power (J2) 0.800 W

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